

HM62W4100HC Series

4M High Speed SRAM (1-Mword × 4-bit)

HITACHI

ADE-203-1202 (Z)

Preliminary

Rev. 0.0

Sep. 28, 2000

Description

The HM62W4100HC is a 4-Mbit high speed static RAM organized 1-Mword × 4-bit. It has realized high speed access time by employing CMOS process (6-transistor memory cell) and high speed circuit designing technology. It is most appropriate for the application which requires high speed and high density memory, such as cache and buffer memory in system. The HM62W4100HC is packaged in 400-mil 32-pin SOJ for high density surface mounting.

Features

- Single supply : 3.3 V ± 0.3 V
- Access time : 10 ns (max)
- Completely static memory
 - No clock or timing strobe required
- Equal access and cycle times
- Directly TTL compatible
 - All inputs and outputs
- Operating current : 115 mA (max)
- TTL standby current : 40 mA (max)
- CMOS standby current : 5 mA (max)
 - : 1 mA (max) (L-version)
- Data retention current : 0.6 mA (max) (L-version)
- Data retention voltage: 2 V (min) (L-version)
- Center V_{CC} and V_{SS} type pinout

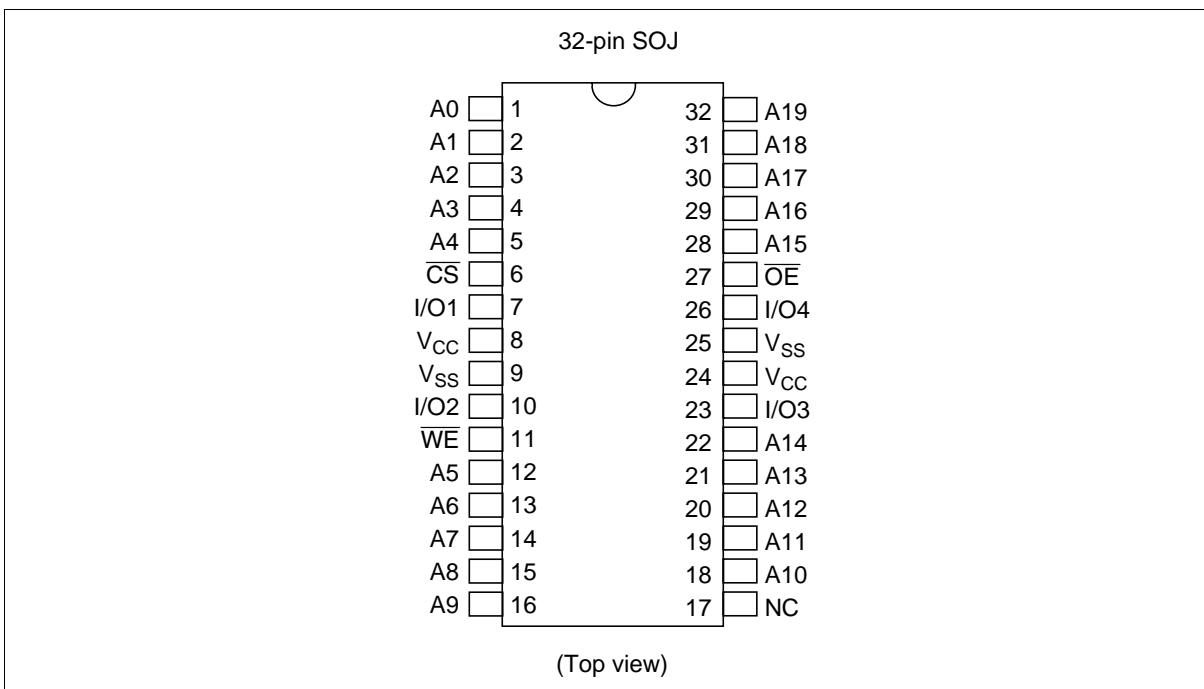
Preliminary: The specification of this device are subject to change without notice. Please contact your nearest Hitachi's Sales Dept. regarding specification.

HM62W4100HC Series

Ordering Information

Type No.	Access time	Package
HM62W4100HCJP-10	10 ns	400-mil 32-pin plastic SOJ (CP-32DB)
HM62W4100HCLJP-10	10 ns	

Pin Arrangement

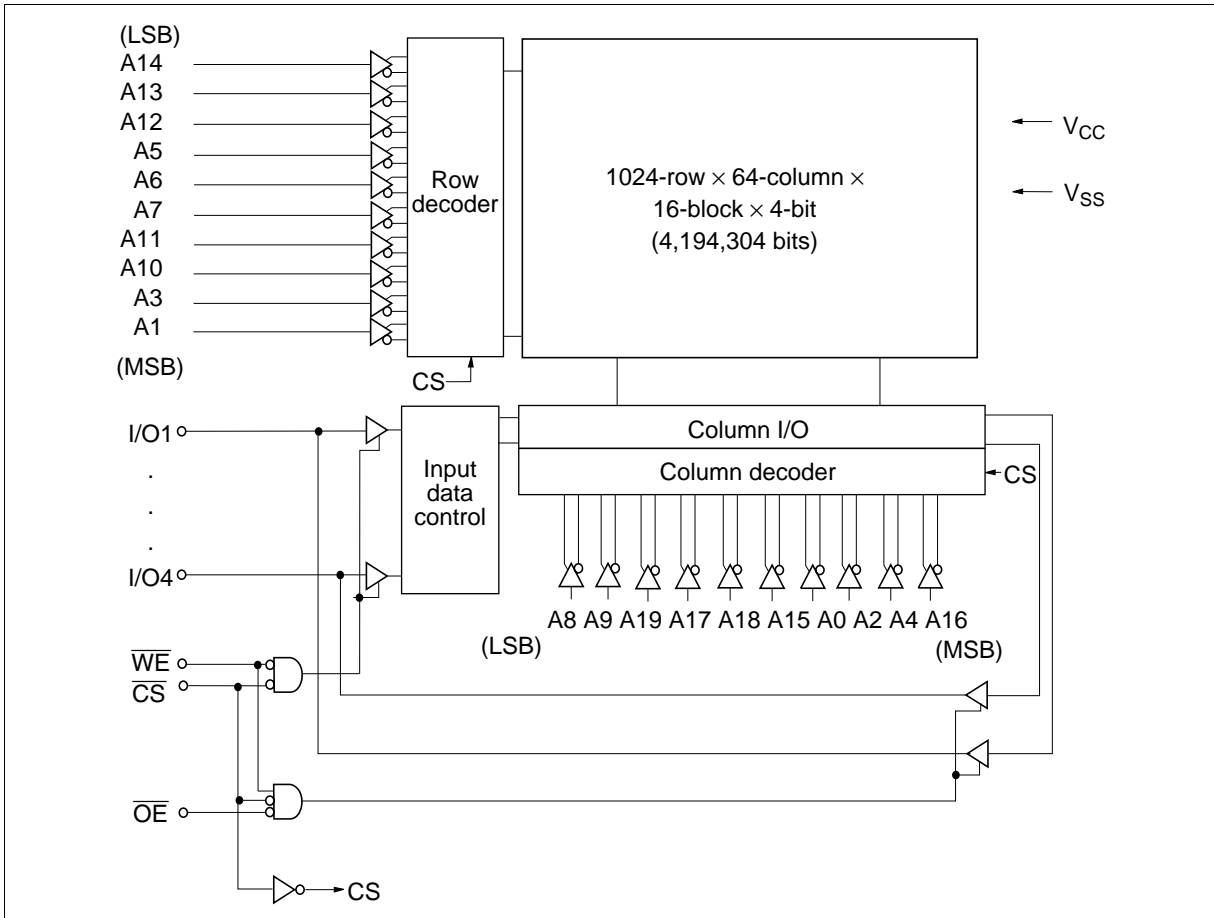


Pin Description

Pin name	Function
A0 to A19	Address input
I/O1 to I/O4	Data input/output
$\overline{\text{CS}}$	Chip select
$\overline{\text{OE}}$	Output enable
$\overline{\text{WE}}$	Write enable
V _{CC}	Power supply
V _{SS}	Ground
NC	No connection

HM62W4100HC Series

Block Diagram



HM62W4100HC Series

Operation Table

\overline{CS}	\overline{OE}	\overline{WE}	Mode	V_{CC} current	I/O	Ref. cycle
H	×	×	Standby	I_{SB}, I_{SB1}	High-Z	—
L	H	H	Output disable	I_{CC}	High-Z	—
L	L	H	Read	I_{CC}	Dout	Read cycle (1) to (3)
L	H	L	Write	I_{CC}	Din	Write cycle (1)
L	L	L	Write	I_{CC}	Din	Write cycle (2)

Note: ×: H or L

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage relative to V_{SS}	V_{CC}	-0.5 to +4.6	V
Voltage on any pin relative to V_{SS}	V_T	-0.5 ^{*1} to $V_{CC}+0.5$ ^{*2}	V
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-55 to +125	°C
Storage temperature under bias	T_{bias}	-10 to +85	°C

Notes: 1. V_T (min) = -2.0 V for pulse width (under shoot) ≤ 6 ns.

2. V_T (max) = $V_{CC} + 2.0$ V for pulse width (over shoot) ≤ 6 ns.

Recommended DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC} ^{*3}	3.0	3.3	3.6	V
	V_{SS} ^{*4}	0	0	0	V
Input voltage	V_{IH}	2.0	—	$V_{CC} + 0.5$ ^{*2}	V
	V_{IL}	-0.5 ^{*1}	—	0.8	V

Notes: 1. V_{IL} (min) = -2.0 V for pulse width (under shoot) ≤ 6 ns.

2. V_{IH} (max) = $V_{CC} + 2.0$ V for pulse width (over shoot) ≤ 6 ns.

3. The supply voltage with all V_{CC} pins must be on the same level.

4. The supply voltage with all V_{SS} pins must be on the same level.

HM62W4100HC Series

DC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0\text{V}$)

Parameter	Symbol	Min	Typ* ¹	Max	Unit	Test conditions
Input leakage current	I_{LI}	—	—	2	μA	$V_{in} = V_{SS}$ to V_{CC}
Output leakage current	I_{LO}	—	—	2	μA	$V_{in} = V_{SS}$ to V_{CC}
Operation power supply current	I_{CC}	—	—	115	mA	Min cycle $\overline{CS} = V_{IL}$, $I_{out} = 0 \text{ mA}$ Other inputs = V_{IH}/V_{IL}
Standby power supply current	I_{SB}	—	—	40	mA	Min cycle, $\overline{CS} = V_{IH}$, Other inputs = V_{IH}/V_{IL}
	I_{SB1}	—	TBD	5	mA	$f = 0 \text{ MHz}$ $V_{CC} \geq \overline{CS} \geq V_{CC} - 0.2 \text{ V}$, (1) $0 \text{ V} \leq V_{in} \leq 0.2 \text{ V}$ or (2) $V_{CC} \geq V_{in} \geq V_{CC} - 0.2 \text{ V}$
		—* ²	TBD* ²	1* ²		
Output voltage	V_{OL}	—	—	0.4	V	$I_{OL} = 8 \text{ mA}$
	V_{OH}	2.4	—	—	V	$I_{OH} = -4 \text{ mA}$

Notes: 1. Typical values are at $V_{CC} = 3.3 \text{ V}$, $T_a = +25^\circ\text{C}$ and not guaranteed.
2. This characteristics is guaranteed only for L-version.

Capacitance ($T_a = +25^\circ\text{C}$, $f = 1.0 \text{ MHz}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input capacitance* ¹	C_{in}	—	—	6	pF	$V_{in} = 0 \text{ V}$
Input/output capacitance* ¹	$C_{I/O}$	—	—	8	pF	$V_{I/O} = 0 \text{ V}$

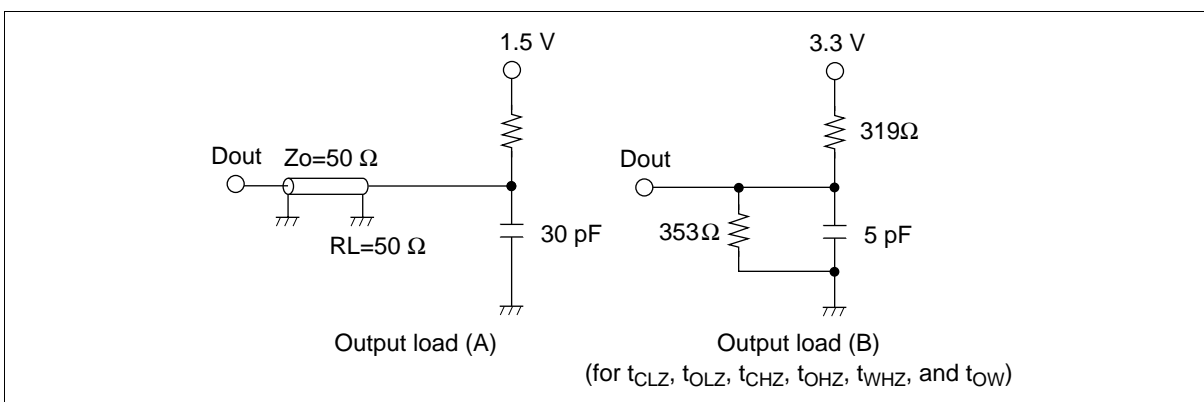
Note: 1. This parameter is sampled and not 100% tested.

HM62W4100HC Series

AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, unless otherwise noted.)

Test Conditions

- Input pulse levels: 3.0 V/0.0 V
- Input rise and fall time: 3 ns
- Input and output timing reference levels: 1.5 V
- Output load: See figures (Including scope and jig)



Read Cycle

Parameter	Symbol	HM62W4100HC		Unit	Notes
		-10			
		Min	Max		
Read cycle time	t_{RC}	10	—	ns	
Address access time	t_{AA}	—	10	ns	
Chip select access time	t_{ACS}	—	10	ns	
Output enable to output valid	t_{OE}	—	5	ns	
Output hold from address change	t_{OH}	3	—	ns	
Chip select to output in low-Z	t_{CLZ}	3	—	ns	1
Output enable to output in low-Z	t_{OLZ}	0	—	ns	1
Chip deselect to output in high-Z	t_{CHZ}	—	5	ns	1
Output disable to output in high-Z	t_{OHZ}	—	5	ns	1

HM62W4100HC Series

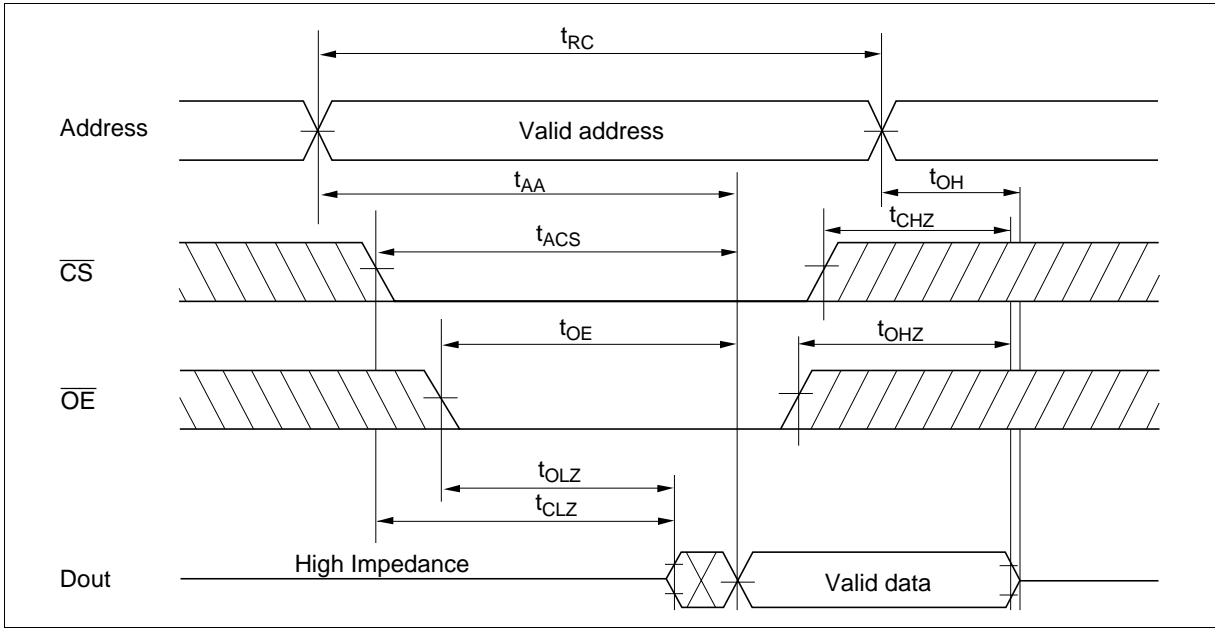
Write Cycle

Parameter	Symbol	HM62W4100HC		Unit	Notes
		-10			
		Min	Max		
Write cycle time	t_{WC}	10	—	ns	
Address valid to end of write	t_{AW}	7	—	ns	
Chip select to end of write	t_{CW}	7	—	ns	9
Write pulse width	t_{WP}	7	—	ns	8
Address setup time	t_{AS}	0	—	ns	6
Write recovery time	t_{WR}	0	—	ns	7
Data to write time overlap	t_{DW}	5	—	ns	
Data hold from write time	t_{DH}	0	—	ns	
Write disable to output in low-Z	t_{OW}	3	—	ns	1
Output disable to output in high-Z	t_{OHZ}	—	5	ns	1
Write enable to output in high-Z	t_{WHZ}	—	5	ns	1

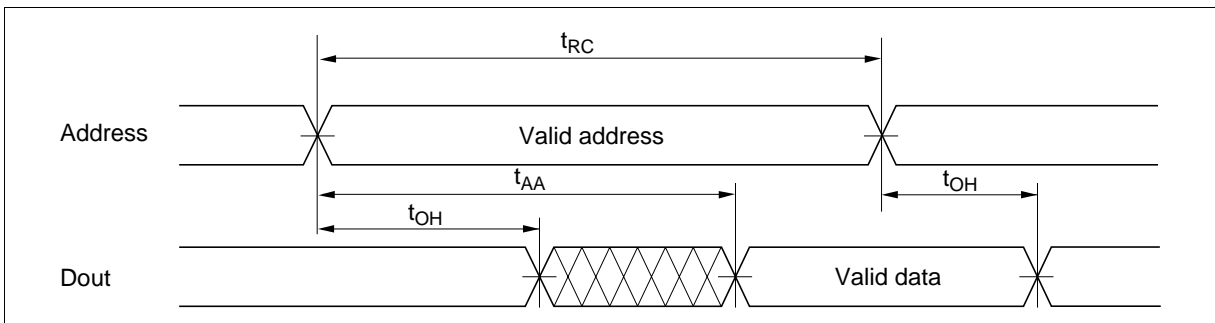
- Note:
1. Transition is measured ± 200 mV from steady voltage with Load (B). This parameter is sampled and not 100% tested.
 2. Address should be valid prior to or coincident with \overline{CS} transition low.
 3. \overline{WE} and/or \overline{CS} must be high during address transition time.
 4. If \overline{CS} and \overline{OE} are low during this period, I/O pins are in the output state. Then, the data input signals of opposite phase to the outputs must not be applied to them.
 5. If the \overline{CS} low transition occurs simultaneously with the \overline{WE} low transition or after the \overline{WE} transition, output remains a high impedance state.
 6. t_{AS} is measured from the latest address transition to the later of \overline{CS} or \overline{WE} going low.
 7. t_{WR} is measured from the earlier of \overline{CS} or \overline{WE} going high to the first address transition.
 8. A write occurs during the overlap of a low \overline{CS} and a low \overline{WE} . A write begins at the latest transition among \overline{CS} going low and \overline{WE} going low. A write ends at the earliest transition among \overline{CS} going high and \overline{WE} going high. t_{WP} is measured from the beginning of write to the end of write.
 9. t_{CW} is measured from the later of \overline{CS} going low to the the end of write.

Timing Waveforms

Read Timing Waveform (1) ($\overline{WE} = V_{IH}$)

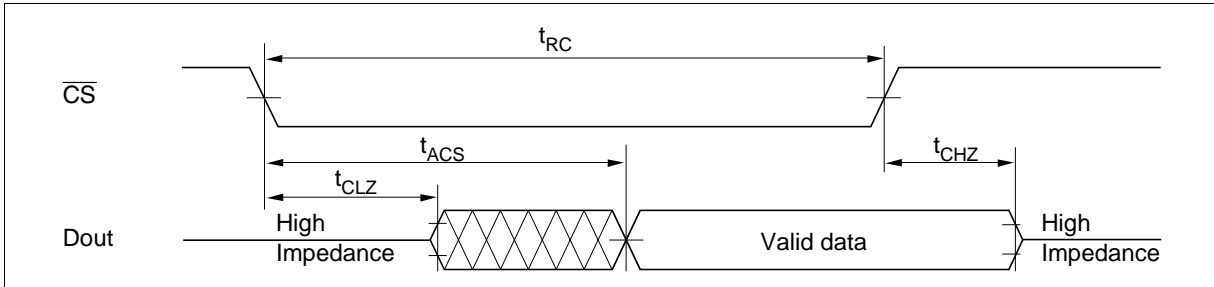


Read Timing Waveform (2) ($\overline{WE} = V_{IH}$, $\overline{CS} = V_{IL}$, $\overline{OE} = V_{IL}$)

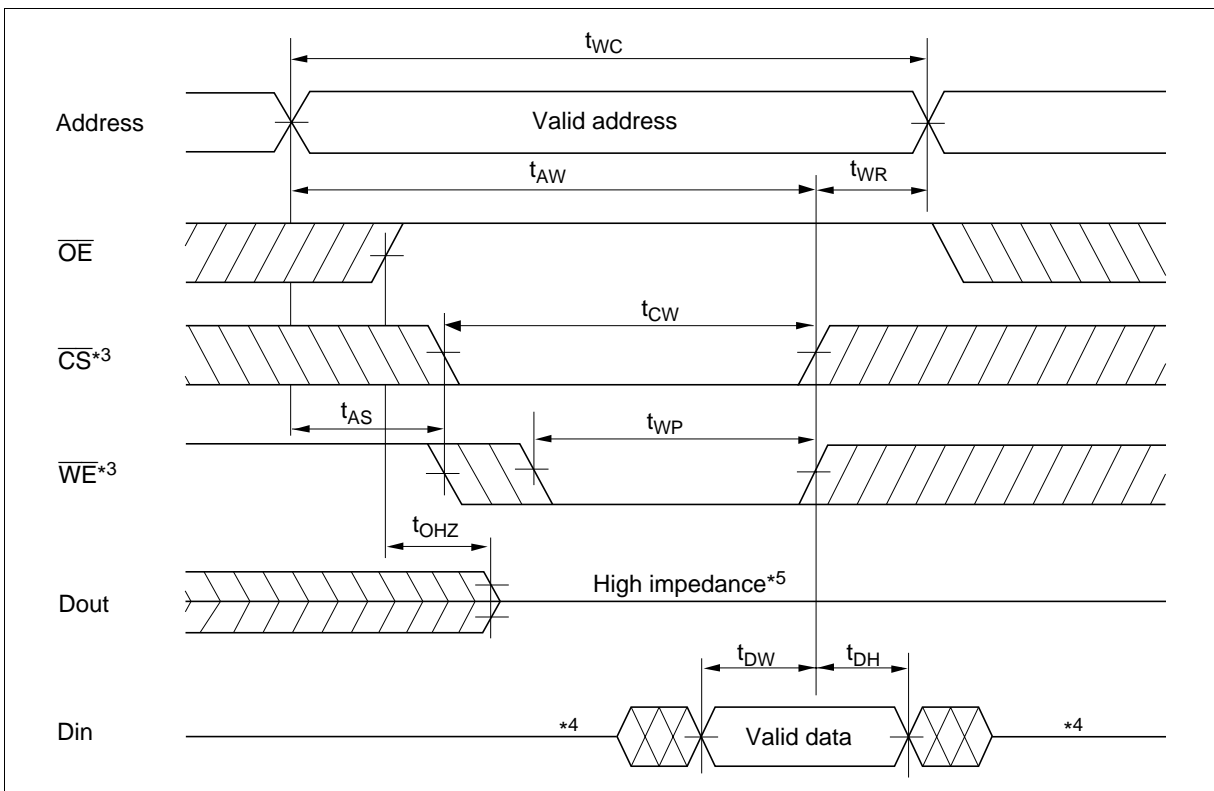


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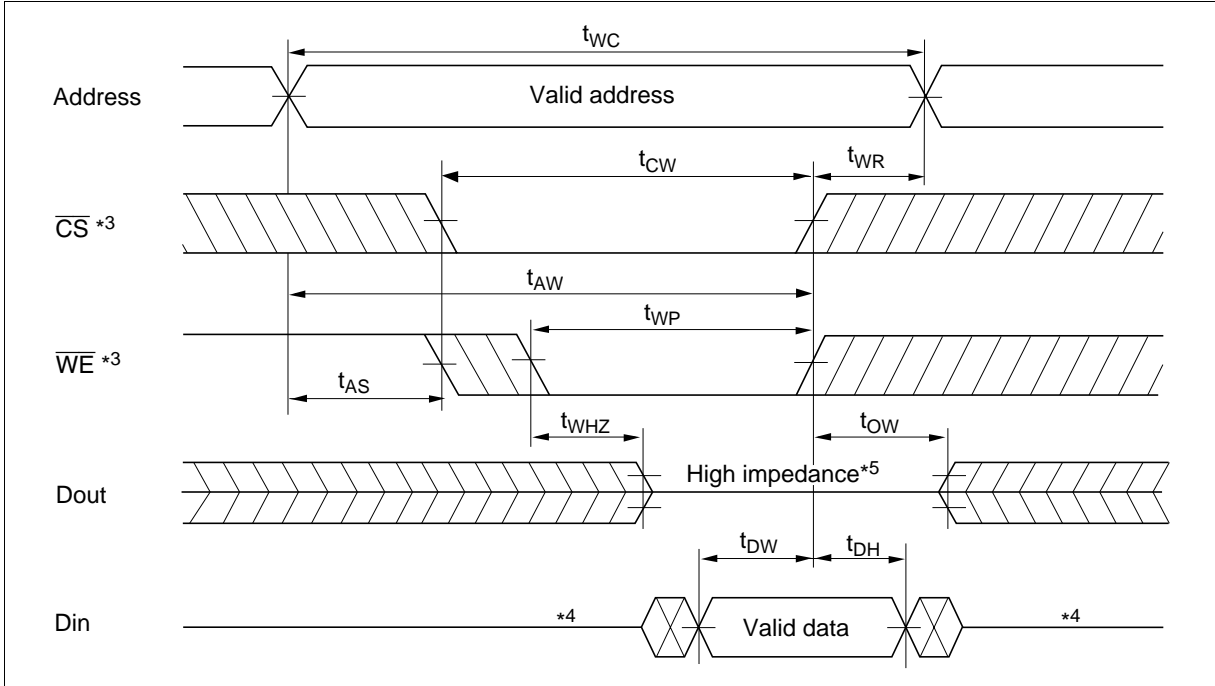
Read Timing Waveform (3) ($\overline{WE} = V_{IH}, \overline{CS} = V_{IL}, \overline{OE} = V_{IL}$)*2



Write Timing Waveform (1) (\overline{WE} Controlled)



Write Timing Waveform (2) (\overline{CS} Controlled)



HM62W4100HC Series

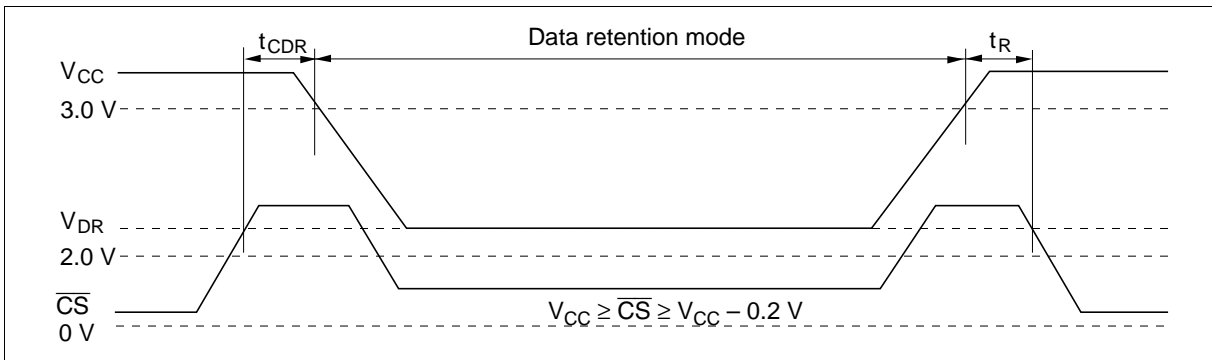
Low V_{CC} Data Retention Characteristics ($T_a = 0$ to $+70^\circ\text{C}$)

This characteristics is guaranteed only for L-version.

Parameter	Symbol	Min	Typ* ¹	Max	Unit	Test conditions
V_{CC} for data retention	V_{DR}	2.0	—	—	V	$V_{CC} \geq \overline{CS} \geq V_{CC} - 0.2$ V (1) $0 \text{ V} \leq V_{in} \leq 0.2 \text{ V}$ or (2) $V_{CC} \geq V_{in} \geq V_{CC} - 0.2 \text{ V}$
Data retention current	I_{CCDR}	—	TBD	600	μA	$V_{CC} = 3 \text{ V}$, $V_{CC} \geq \overline{CS} \geq V_{CC} - 0.2 \text{ V}$ (1) $0 \text{ V} \leq V_{in} \leq 0.2 \text{ V}$ or (2) $V_{CC} \geq V_{in} \geq V_{CC} - 0.2 \text{ V}$
Chip deselect to data retention time	t_{CDR}	0	—	—	ns	See retention waveform
Operation recovery time	t_R	5	—	—	ms	

Note: 1. Typical values are at $V_{CC} = 3.0 \text{ V}$, $T_a = +25^\circ\text{C}$, and not guaranteed.

Low V_{CC} Data Retention Timing Waveform

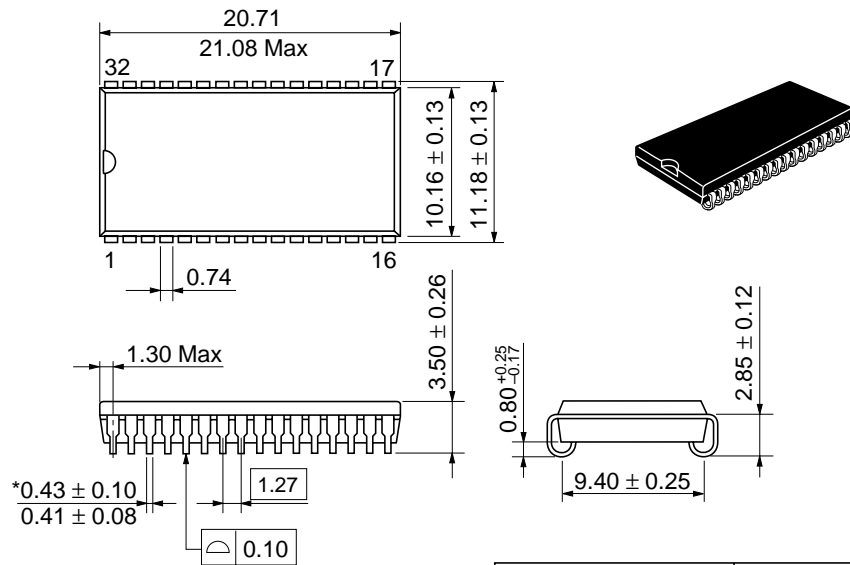


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Package Dimensions

HM62W4100HCJP/HCLJP Series (CP-32DB)

Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	CP-32DB
JEDEC	Conforms
EIAJ	Conforms
Mass (reference value)	1.2 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL NorthAmerica : <http://semiconductor.hitachi.com/>
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic Components Group
Dornacher StraÙe 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 585160

Hitachi Asia Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3rd Flr, Hung Kuo Building, No.167,
Tun Hwa North Road, Taipei (105)
Taiwan
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180
Telex: 23222 HAS-TP

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7th Flr, North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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